

Meeting Minutes PDCC Ad Hoc
Prepared by: Chad Jones
4 January 2023
1PM ET

1:02PM Meeting called to order.

Meeting started by the Ad Hoc Chair, Chad Jones.

1:03PM The Chair reviewed agenda slides, covered the IEEE patent policy, code of ethics and conduct, individual process, equitable consideration of all viewpoints, and copyright rules (slides 3-7 in the agenda deck).

1:06PM The Chair informs the group that minutes for the previous meeting are posted, asked if anyone that wanted to review the minutes hadn't had the chance to review, and asked if there were any changes to be made to the minutes. None responded. The minutes were approved by unanimous consent. The Chair instructed the webmaster to change the status of the 14 December 2022 minutes to confirmed.

1:07PM The only agenda item was reviewing the presentation that the chair prepared of the consolidated comments on 11801-1 and 1 and 11801-9911. The original file to review is here (all files password protected):

https://www.ieee802.org/3/ad_hoc/PDCC/private/11801/11801_802d3_comments_4Jan23.pdf

Post meeting file containing the notes from the meeting:

https://www.ieee802.org/3/ad_hoc/PDCC/private/11801/11801_802d3_comments_4Jan23v1.1.pdf

Cleaned up version removing all the notes and performing the action items:

https://www.ieee802.org/3/ad_hoc/PDCC/private/11801/11801_802d3_comments_4Jan23v2.pdf

After the meeting, the chair was sent a copy of the comment template used by SC25. The rules of the 802.3 and SC25 liaison relationship do not allow 802.3 to directly comment against 11801-1 and 1, and luckily there are no suggested comments against this document after the final review. Comments against -1 would have had to have been made via an expert contribution. IEEE 802.3 is allowed to comment against -9911 and the PDCC does recommend commenting against this document. The chair will reformat the resulting comments found in the third file above into the comment form and post for review before the next scheduled ad hoc meeting.

2:03PM The next scheduled meeting is 16 Jan 2023, 1PM ET, 2 hours in duration. This occurs during the January Interim meeting series. Agenda will be to review the comment file in preparation for presenting to the 802.3 WG for approval. Also, a liaison reply needs crafted for the request from SC25 for use cases and a paragraph to add to the liaison reply to SC25 for IEEE P802.3dg. The Chair will work with them to get those prepared for the next meeting.

2:05PM The Chair asked if there was any other business, none responded. Having exhausted the allotted meeting time, the meeting was adjourned.

Attendance (from Webex):

Name	Employer; Affiliation	Present
Bob Voss	Panduit Corp.; Panduit Corp.	*
Chad Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	*
Eric Horsma	ADI; ADI	*
Fred Dawson	Chemours Canada Company; Chemours Canada Company	*
George Zimmerman	CME Consulting; CME Consulting/APL Group, CommScope, Cisco Systems, Marvell, OnSemi, and SenTekse	*
James Withey	Fluke Corporation; Fluke Corporation	*
Jon Lewis	Dell/EMC; Dell/EMC	*
Marek Hajduczenia	Charter Communications; Charter Communications	*
Ron Tellas	Belden; Belden	*
Wayne Larsen	CommScope; CommScope	*
Arkadiy Peker	Microchip; Microchip	
Bernd Horrmeyer	Phoenix Contact; Phoenix Contact	
Bill Powell	Independent	
Blake Brown	UNH-IOL; UNH-IOL	
Brian Welch	Cisco; Cisco	
Chris DiMinico	MC Communications; Panduit	
Clark Carty	Cisco Systems, Inc.; Cisco Systems, Inc.	
Craig Chabot	UNH-IOL; UNH-IOL	
Curtis Donahue	UNH-IOL; UNH-IOL	
Dave Hess	Cord Data; Cord Data	
David Brandt	Rockwell Automation; Rockwell Automation	
David Law	Hewlett Packard Enterprise; Hewlett Packard Enterprise	
David Piehler	Dell; Dell	
David Tremblay	Hewlett Packard Enterprise; Hewlett Packard Enterprise	
Denis Beaudoin	TI; TI	
Dillian Reyes	ADI; ADI	
Dino Pozzebon	Microchip; Microchip	
Earl Parsons	Commscope; Commscope	
Frank Effenberger	Futurewei Technologies; Futurewei Technologies	
Frank Lambrecht	Xilinx; Xilinx	
Geoff Thompson	Unemployed; Unaffiliated	
Gergely Huszak	Kone; Kone	
Heath Stewart	ADI; ADI	
Jason Potterf	Cisco; Cisco	
Jeff Lapak	UNH-IOL; UNH-IOL	
Jennifer Santalli	STAFF	
Jodi Haasz	STAFF	
Joel Goergen	Cisco; Cisco	
John Deandrea	Finisar Corporation; Finisar Corporation	
John Kamino	OFS; OFS	
John S Abbott	Corning; Corning	
Jose Castro	Panduit; Panduit	
Joseph Aronson	TI; TI	
Joshua Kim	Hirose US; Hirose US	
Kazuhiko Ishibe	Anritsu; Anritsu	
Ken Bennett	Sifos; Sifos	
Ken Schneider	Telebyte, Inc.; Telebyte, Inc.	
Kent Lennartsson	Kvaser AB; Kvaser AB	
Kevin Peters	Inneos; Inneos	

Name	Employer; Affiliation	Present
Larry McMillan	Western Digital Corporation; Western Digital Corporation	
Lars Ellegaard	Microchip; Microchip	
Lennart Yseboodt	Signify; Signify	
Ling Chen	Huawei Technologies Co., Ltd; Huawei Technologies Co., Ltd	
Mark Dearing	Leviton; Leviton	
Masood Shariff	Commscope; Commscope	
Matthew Ceglia	STAFF	
Matthias Fritsche	HARTING Technologie Gruppe; HARTING Electronics GmbH	
Matthias Wendt	Signify; Signify	
Mehmet Tazebay	Broadcom; Broadcom	
Mick Maytum	Independent	
Neil Mabbott	British Cables Association; British Cables Association	
Oloruntobi Femi	Corning; Corning	
Oluwafemi Akinwale	Intel Corporation; Intel Corporation	
Pat Roder	STAFF	
Paul Nikolich	Self, HPE, Huawei, Itron, octoScope, Wyebot, UNH BCoE, YAS BBV, Origin Wireless	
Paul Vanderlaan	UL LLC; UL LLC	
Pavel Zivny	Tektronix; Tektronix	
Peter Fischer	BKS Kabel-Service AG; BKS Kabel-Service AG	
Peter Jones	Cisco Systems, Inc.; Cisco Systems, Inc.	
Qiwen Zhong	Huawei Technologies Co., Ltd; Huawei Technologies Co., Ltd	
Rick Pimpinella	Panduit; Panduit	
Roger King	Trumpf Photonic Components; Trumpf Photonic Components	
Rui Zhang	JPCCO; JPCCO	
Sam Kocsis	Amphenol Corporation; Amphenol Corporation	
Sami Akin	Volkswagen AG; Volkswagen AG	
Semmy Peng	Huawei; Huawei	
Sridhar Ramesh	Maxlinear; Maxlinear Inc	
Stephan Schreiner	Rosenberger; Rosenberger	
Steve Carlson	High Speed Design; High Speed Design	
Steve Devine	The IET; The IET	
Theo Brillhart	Fluke Networks; Fluke Networks	
Valerie Maguire	Siemon; Siemon	
Victor Renteria	Bel; Bel	
Yair Darshan	Microchip; Microchip	
Yang Zhiwei	ZTE Corporation; ZTE Corporation	
Yong Kim	Axonon; Axonon	